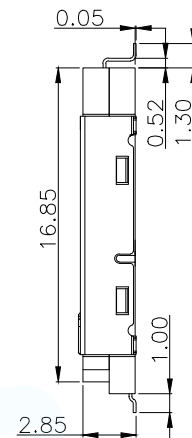
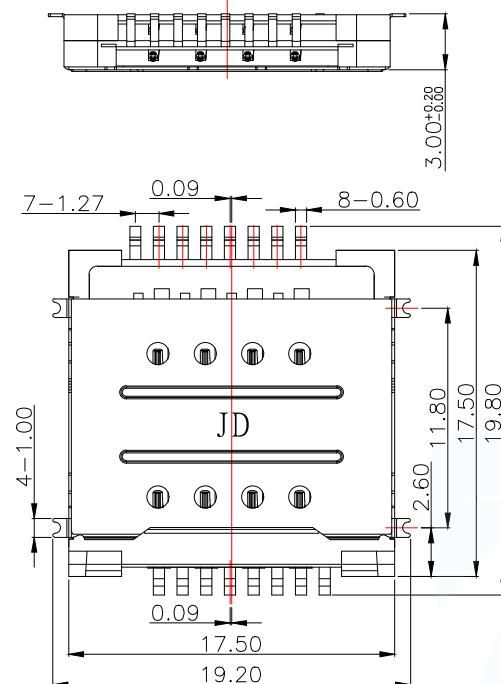
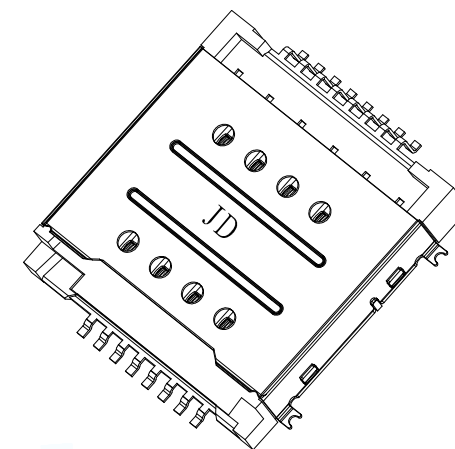


双层 SIM CARD CONNECTOR (短上层)



PIN NO.	PIN NAME
C1	VCC
C2	RST
C3	CLK
C4	Reserved
C5	GND
C6	VPP
C7	I/O
C8	Reserved



NOTES:

1.MATERIAL

HOUSING:THERMOPLASTIC,UL94V-0;COLOR:BLACK

CONTACT:COPPER ALLOY

SHELL:STAINLESS STEEL

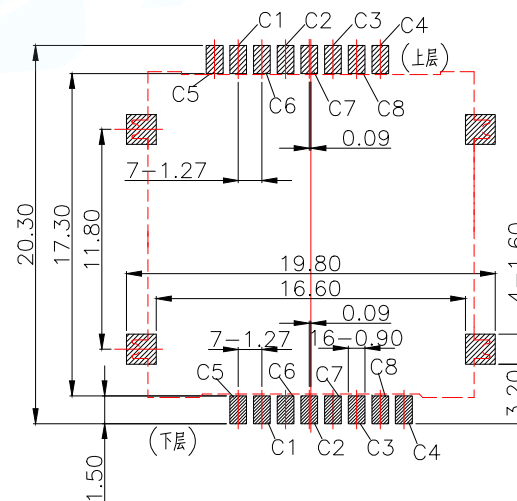
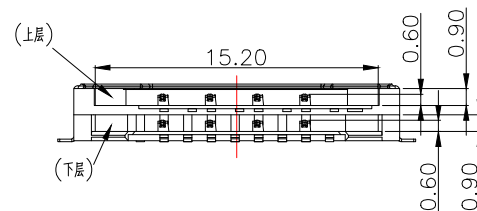
2.FINISH

CONTACT: NICKEL UNDERPLANED AND GOLD PLANTING OVER ALL.

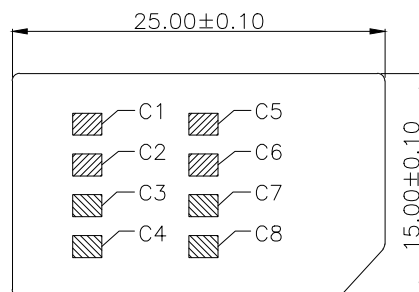
OR NICKEL UNDERPLANED AND GOLD PLANTING ON CONTACT AREA;Tim PLANTING ON SOLDER AREA

SHELL: NICKEL UNDERPLANED AND GOLD PLANTING ON SOLDER AREA.

Operating temperature:-40°C~+85°C



Recommended P.C.B.
Layout(Tolerance=±0.05)
AS VIEW FORM COMPONENT SIDE



MANUFACTURE DWG		 东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co.,Ltd	
UNLESS OTHERWISE SPECIFIED TOLERANCES			
DECIMALS:	ANGLES:	TITLE: 双层多合一卡座	
X.:±0.50	.X":±3°	PAR	MCS-102JD
X.X:±0.30	.XX":±2°	DWN	
X.XX:±0.20		CHKD	
		APVD	
		SCALE:1:1	UNIT:MM
		SIZE:A4	SHEET:1F1
		CUSTOMER COPY	REV:A